

[54] **BLANK FACEPLATE UNIT FOR PRINTED CIRCUIT BOARD MODULE RACKS**

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[**] Term: 14 Years

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[52] U.S. Cl. D13/184; D13/182

[58] Field of Search D13/35, 40, 41, 99; D14/144; 361/331, 342, 346, 380, 381, 383, 390-395, 397, 399, 400, 413, 415-417, 419, 420; 200/302.1, 193; 439/135, 136, 142, 148, 718, 893, 901; 307/116, 118

[56] **References Cited**

U.S. PATENT DOCUMENTS

D. 215,848	11/1969	Stallebrass	D13/99
D. 263,224	3/1982	Peroni	D13/41
D. 268,754	4/1983	Chaney et al.	D13/40
D. 272,819	2/1984	Bean et al.	D13/12

D. 274,615	7/1984	Bean et al.	D13/12
D. 295,402	4/1988	Fitzpatrick et al.	D13/99
D. 296,432	6/1988	Harris et al.	D13/12
4,660,280	4/1987	Asai et al.	D13/99 X

OTHER PUBLICATIONS

Electronics, 2-17-77, p. 22.

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[57] **CLAIM**

The ornamental design for a blank faceplate unit for printed circuit board module racks, as shown.

DESCRIPTION

FIG. 1 is a perspective view of a blank faceplate unit for printed circuit board module racks showing my new design;

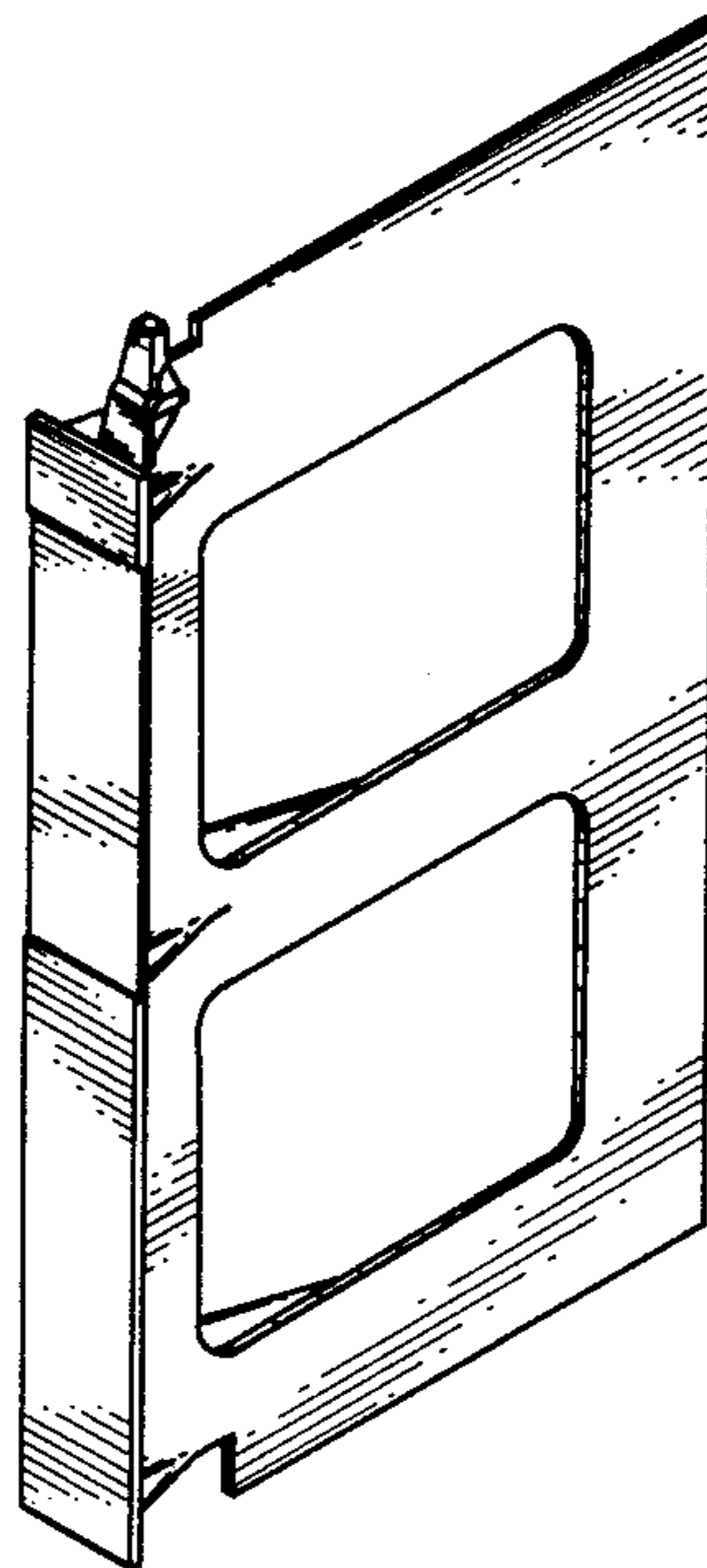
FIG. 2 is a right side elevational view thereof;

FIG. 3 is a left side elevational view thereof;

FIG. 4 is a front elevational view thereof;

FIG. 5 is a rear elevational view thereof;

FIG. 6 is a rear perspective view thereof.



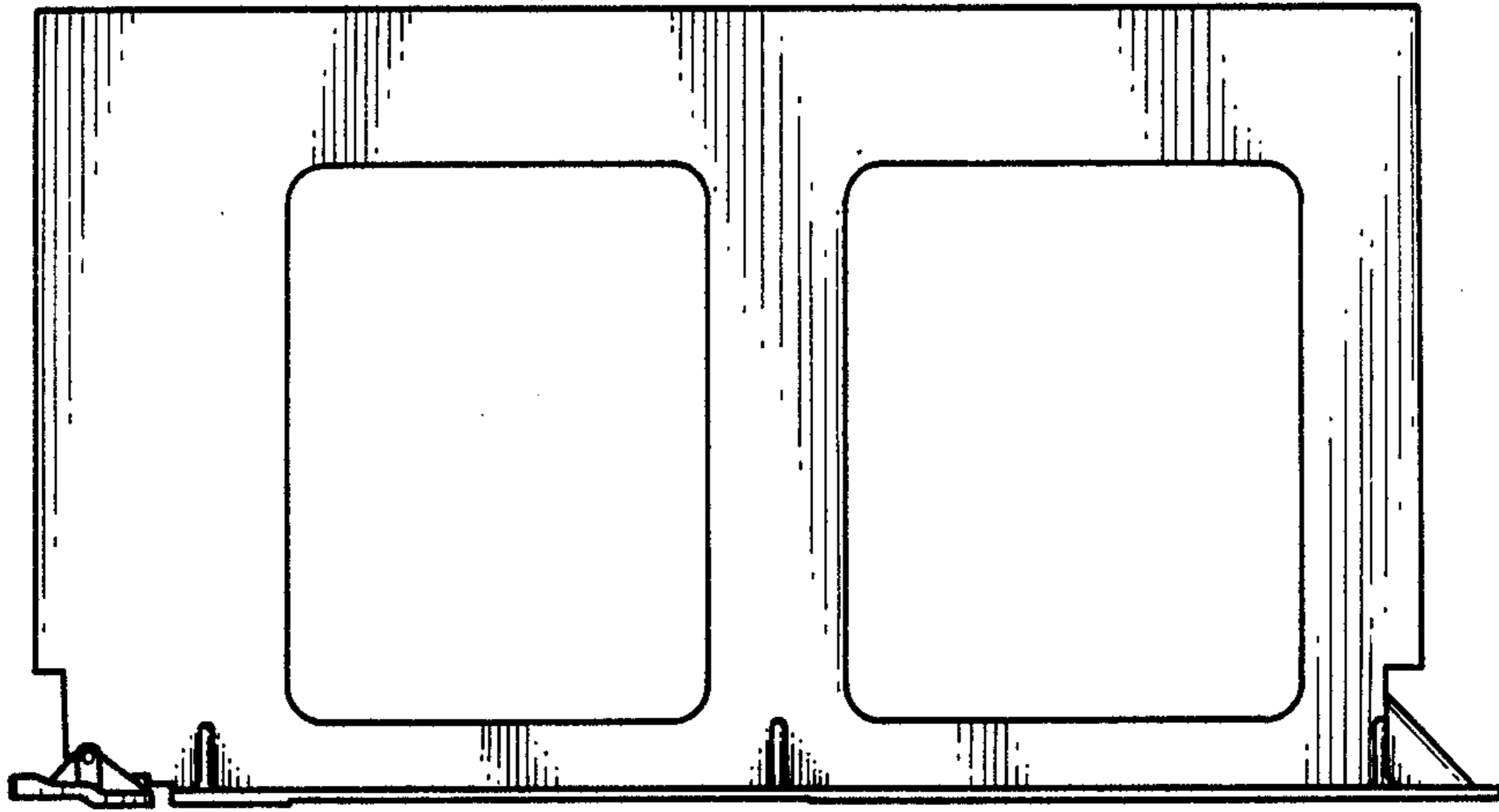


FIG. 2

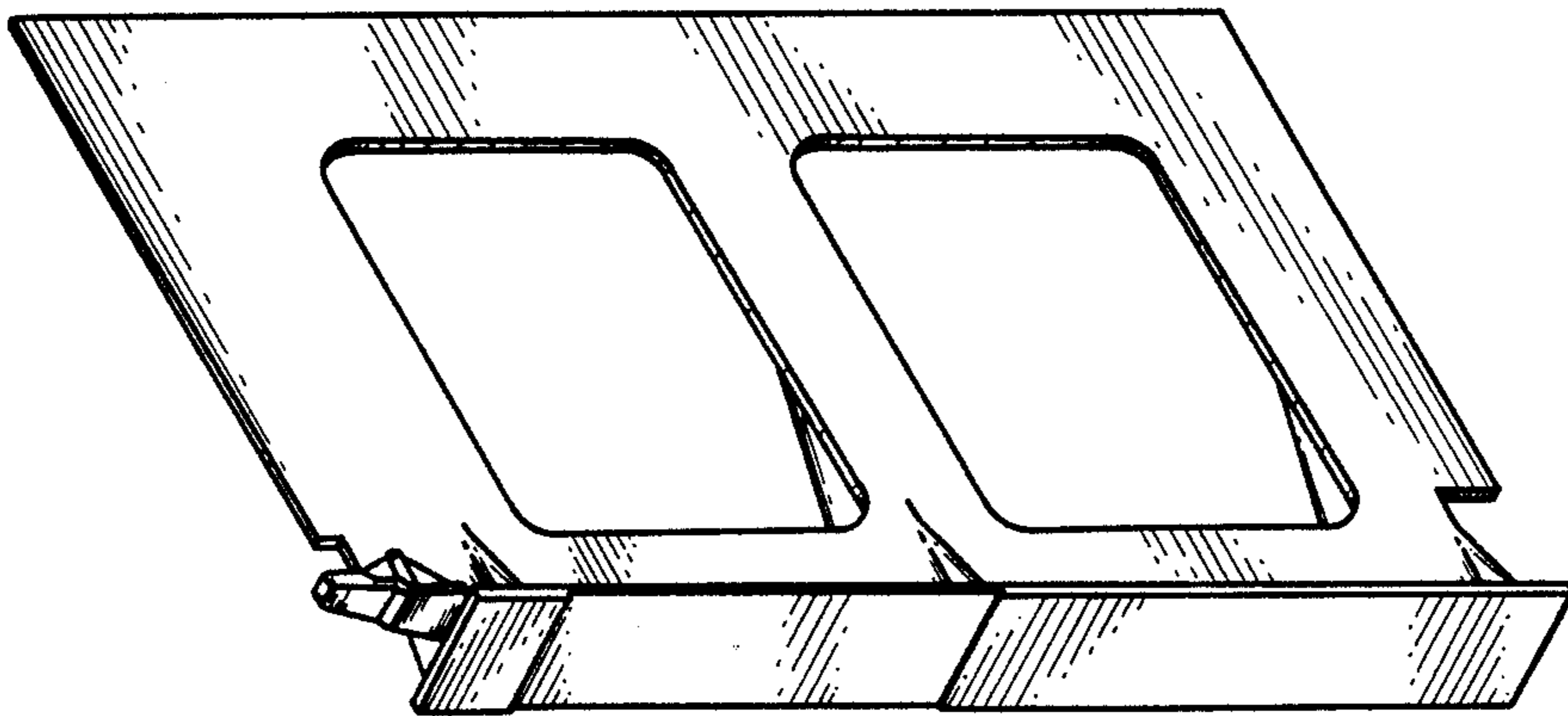


FIG. 1

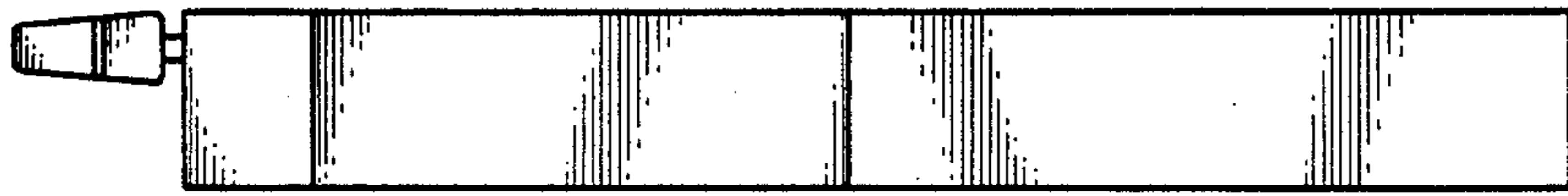


FIG. 4

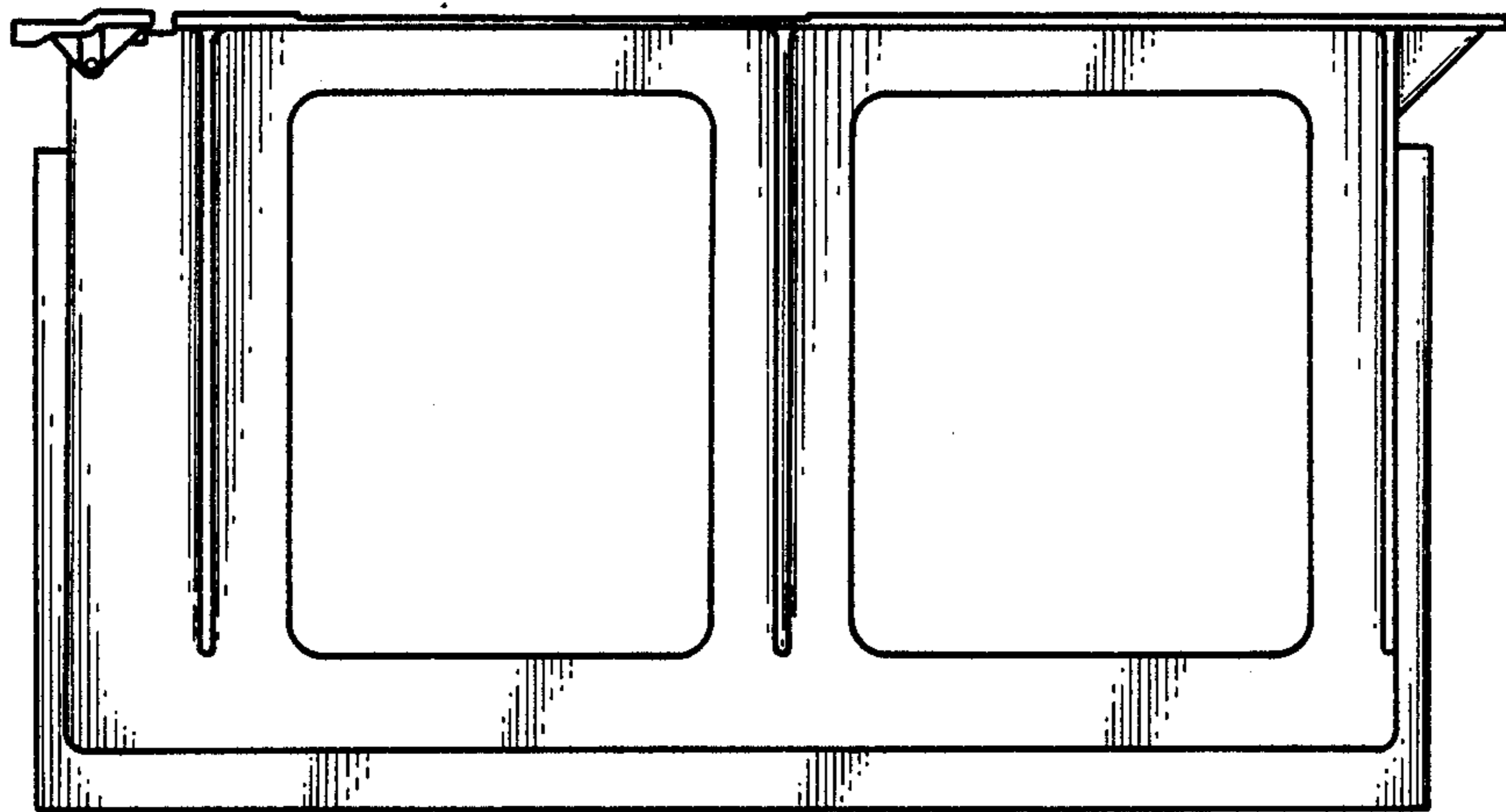


FIG. 3

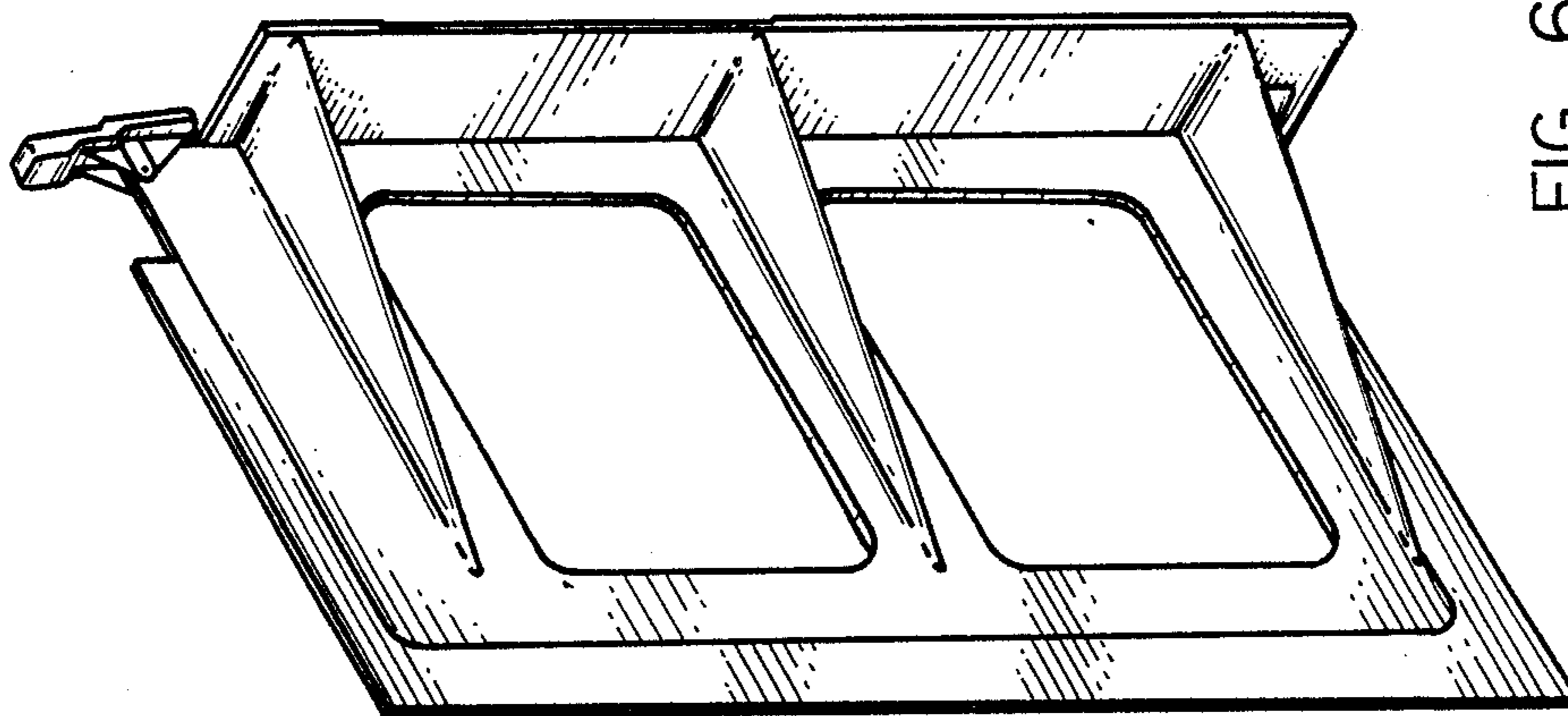


FIG. 6

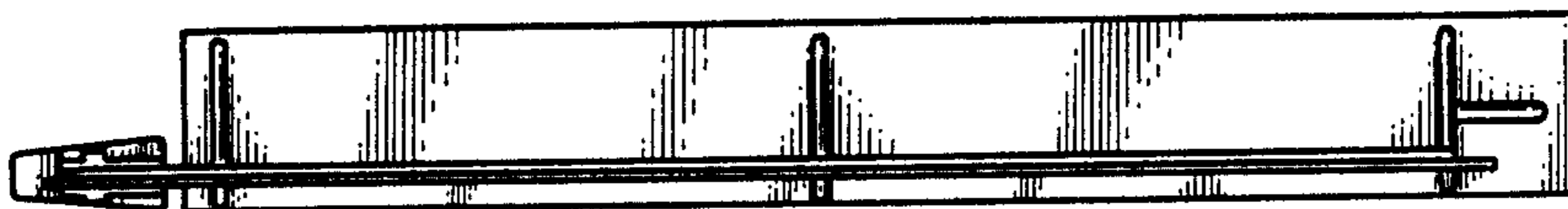


FIG. 5